Bipolar Junction Transistor

Junction TXR: - In 1951, William invented the first junction transistor, & semilonductor device that can amplify. electronic ston such as hadro and telivision ston.

Thansistor es a three terminal Device; Base, Emitter, and Collector. can be operated in three Configurations common, base, Common Emitter and Common Collector.

Transistor was Entented Dr. william shockley and Dr. John Bardeen at bellaboratory in 1951. It is a three terminal device, The output voltage, current or power are controlled by Enput current in a transistor. Therefore it is called a Current Controlled device. In Short Transistor Es also called as BJT stands for Bipolar Junction dransistor because the transistor operation is Careed out by two types of charge Certiers ise majority Carriess and minority

& There are 2-types of transistors.

Current Conduction is ordy due to one type of Carriers : je maj carriers 1 unipolar junction transistos: -

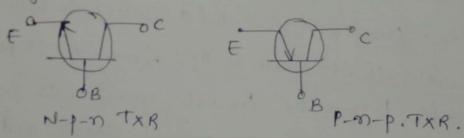
@ Bipolar Junction transistor: The Current Conduction in BJT is because of both the types of Charge Carriers. electrons and holes.

*BIT are 2 types! -

^{1.} n-p-n types 2. P-n-p types.

The middle region is always Base of the txR. This regions are Called

this and lightly doped The remaining two regions are Called Emitter and Collector are heavily doped. But The doping level in conittee is slightly greater then Collector. And Collector Area is slightly greater then Collector. And Collector Area



A thousistor has two P-n junctions one junction is b/w emitter and bake and is called emitter base junction (JE) The other junction (Is b/w the base and collector called collector base junction (Jc). Thus transistor is like two p-n junction diodes connected back-to-back.

Emitter: - The function of emitter is to inject charge carriers of earl holes) to the base bregion.

B P M P C B

Base: - The function of base to pass tell the Charge carriers onto

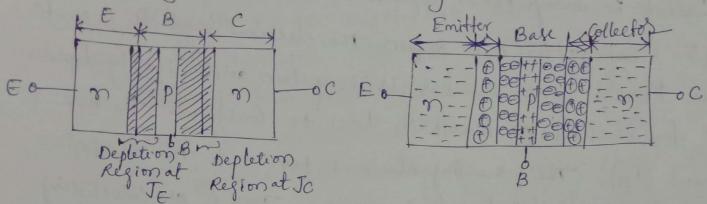
Collector: - The function of Collector Es to Collect charge Carriers.

Unbiased transistos: -

unbiased TXR means, transistor with no External Moltage es applied. Therewill be no current flowing from any of the translittor. Since transistor is like a two p-n junction diodes Connected back to back, there are y regions at both the junctions.

depletion

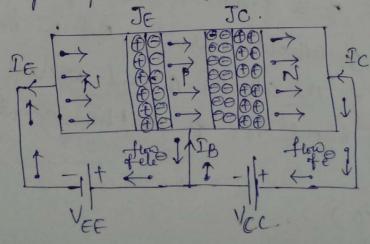
at Emitter function and Collector function.



During diffusion process, depletion region penetralis more deeply into lightly doped side in order to include an equal number of impurity atoms in the each side of the junction.

Dorking of N-p-ord Transistor: -

let us Consider n-p-n TXR, the base Emitter junction is forward biased by dC Source VEE Thus The depletion depletion hegion width is reduced, The Collector base junction is henre biased increasing depletion region at Collector to base junction.



The forward bias of on Emitter base junction pushes a large ? no of thee elections in the N- type Emitter towards the bay This makes the emotter Current (IE). I very few holes also. pars from base to emitter region. This flow of electrons and holes Constitute a Current Ic. The direction of conventional Current is always taken opposite do the flow of electrons. After heaching the base hegion the electrons tend to recombine with holes. Since the base is very thin and lightly doped only few electrons pombine with holes to Constitute the bare Current (IB). The tremaining electrons pars on to the Collectors which is positively biased N-region. There is are Collected by Collector to Constitute the Collector Current.

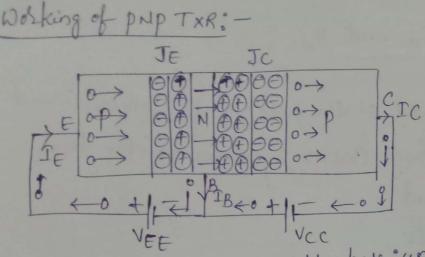
There is an another Current (Collector Current) due to the thermally generaled minority carriers (Holes in This Case) which pars towards une base. This small current is called heners Satisfaction Current.

It Es clear Emetter Current is sum of base current plus Collector Cerrent $Te = T_8 + T_c$

The Emitter Current of a transistor Consists of two Components There are base Current of Collector Current. But the base current is only about 2% of the Collector current whereas the Collector Current is about 98% of Emitter Current.

· TEZIC.

(IBZO)



The is necessary to FB the emitter base junction and henerchias

The Collector base junction. The FB JE Causes the holes in the

P-type emitter to flow towneds the base. This constitutes the

emitter current It. As these holes flow through the m-type base,

they lend to Combine with electrons in n-region (base). As

they lend to Combine with electrons in n-region (base). As

the base is very thin and lightly doped, very few of the holes

injected into the base from the emitter recombine with electrons

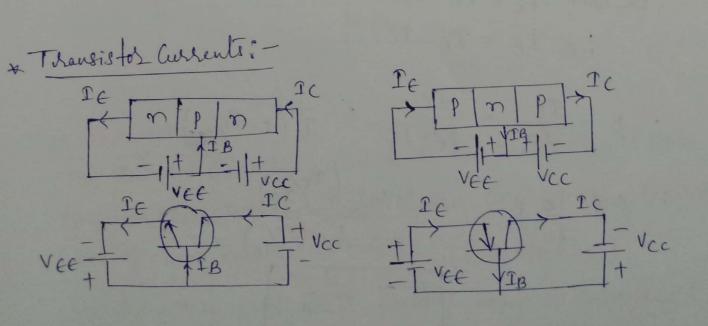
to constitute base current, IB hemaining targe no of holes

Chors the depletion begion and more through the Collector

hegion to the negative ferminal of the External d.c Source.

This constitute Collector Current IC. Thus the holes flow constitute

the dominant current in an p-n-p TxR.



Defination of ddc and Bdc ?

di- It is defined as the hatio of the Collector Current Lesulting from Carrier injection to the total.

Emitter Current:

2 = dc = Ic

i dis lenthanuaity i.e 0.95 to 0.995. Coz Ic (IE.
It represents in CB Configuration.

 $\frac{\beta_{dC}}{}$ = $\frac{1}{2}$ & defined as the ratio of the collector Current.

For the base current. $\frac{\beta_{dC}}{\beta_{dC}} = \frac{\Gamma_{C}}{\Gamma_{B}}$.

Relation ship blw &dc and Bdc; -

We know that, $\beta = \frac{Ic}{TR}$, $\alpha = \frac{Ic}{TE}$

.. we have IE = IB + IC

$$\beta = \frac{Ic}{IB} = \frac{Ic}{Ie-Ic} = \frac{Ic}{Ie(1-Ie/Ie)}$$

$$= \frac{(f/f_e)}{1-(f/f_e)}$$

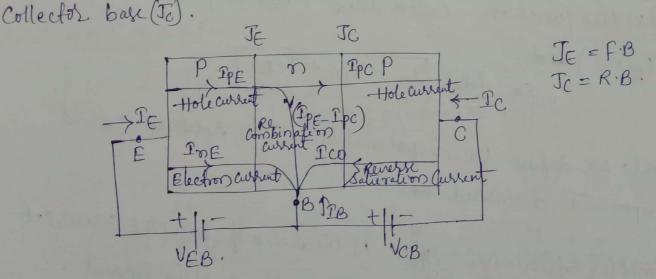
$$= \frac{(f/f_e)}{1-(f/f_e)}$$

$$= \frac{1}{1-\alpha}$$

By dividing (1+
$$\beta$$
) on both sides,
$$\frac{\beta}{(1+\beta)} = \frac{\alpha(1-\alpha)}{(1+\beta)}$$

$$\frac{\beta}{1+\beta} = \frac{\alpha}{1-\alpha} \implies \frac{\alpha}{1-\alpha$$

Various Current Components in p-n-p transistor which flow aeron the Forward biased emitter base junction (JE) and the reverse biased



The Emitter Current IE Consists of hole Current IPE (Holes Croning,
from emitter into base) and electron current InE (electron
Choning from base to emitter). (IE=IPE+INE).

In transistor Emitter is heavily doped as Compared to
base, Thus, electron current is negligible as Compared
to Current.

Thus Emitter Current in PNP teansistor is mainly du the flow of holes from emitter to base. Au the holes Croning the emitter base function do not neach in Collector junction. be cause some of them Combine with electron Since width of the base is very small, most of holes cron the in Ntype base. Collector junction Jc and relevy few electrons recombine, Constitute une base Current IB = (IPE-IPC) Reverse Saturation Current; -Since Collector Correct Es R.B., Which acts as renerse biased PN junction diode, a reverse Saturation Current Ico flows acres this junction. Called IcBO (Businessopen Circuitary, i.e. So total Ic = Ipc + Iego. [= = 0) made Now, we define Various paremeters which relete the Current Components discursed about. Emitler Enfliciency & - (16); is the datio of Injected Carliers at Enuter base junction to total Emiller cemitter Current. The Current of injected carriers at JE Total Emitter Current Incar Y = IPE = IPE P-n-P IPE+InE = IE. (: IPE >> InE Since y nearly Equal to 1)

El Mansport Factor (B): -It is the ratio of injected Carriers aurent reaching at Collector base Junction To to injected Carriers at emitter base function JE

B = IPE

IPE larges In Current Gain (dd); -It is the Iratio of Current due to the injected Carriers Ipc to total emitler Current IE. : Ic = Ipc + Ico de = Ipc = Ic-Ico
IE Ipc= Ic-Ico da. IE = IC-Ico.

Ic = ddc. IE + Ico relation blw & Biy! - $\alpha = \frac{1}{2}pc$ By multiplying numerator of Denominator by IPE d= Ipc x Ipe Ipe Ie

 $\begin{array}{c|c}
\hline
TPE & TE \\
\hline
C = B * Y
\end{array}$ $\begin{array}{c|c}
\hline
P = Tpc \\
\hline
Tpe \\
\end{array}$ $\begin{array}{c|c}
Y = Tpe \\
\hline
Te \\
\end{array}$ $\begin{array}{c|c}
\ell \\
\end{array}$

The transistor alpha is the product of transport factor and emitter efficiency.

and 190.

b) Find B for each of the Value of \$20.995 and 0.9765

Soli-a) N-B

$$Soli-a$$
) $\alpha = \frac{\beta}{1+\beta}$.

b) :
$$\alpha = 0.995$$
; $\beta = \frac{\alpha}{1-\alpha} = \frac{0.995}{1-0.995} = 199$

$$\beta = 0.9765$$
; $\beta = \frac{\alpha}{1-\alpha} = \frac{0.9765}{1-0.9765} = 41.55$

2) If the base current in a transistor is 20pet when the Emitter Current is 6.4mA, what are the relies of dc and pd.c? Also Calculate the Collector Current?

Sol;-
$$\Sigma_B = 20\mu A$$
, $\Sigma_C = 6.4mA$
 $\alpha = \beta$: $\Sigma_C = \Sigma_B + \Sigma_C$

$$= 6380 \mu A$$

 $= 6.38 m A$

$$T_{c} = \alpha T_{c}$$

$$= 0.9968 \times 6.4 \times 10^{3}$$

$$T_{c} = 6.379 \text{ MA}$$

$$I_{\epsilon} = (1+\beta)^{T}B$$

$$(1+\beta) = I_{\epsilon}$$

$$T_{B}$$

IB+BIB

$$\beta = \frac{IB}{IB} \rightarrow \frac{6.4 \times 10^{3}}{20 \times 10^{6}} - 1$$

$$\beta = 320 - 1$$
 $\beta = 319$

BIT Configuration: -TrR canbe connected in a cht in the following three

Configurations.

1. Commonbase Configuration

2. Common Emitter Configuration

3. Common Collector Configuration.

1) Common base Configuration: -

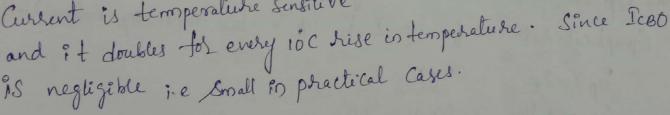
In this configuration Expert is applied blw Emitter and base and orp is taken from the Collector and base. Hence base of the transistor is Common to both input and output circuits and hence the name

Common base Configuration.

-Here Tc = dec TE + ICBO.

ICBO is herese saturation

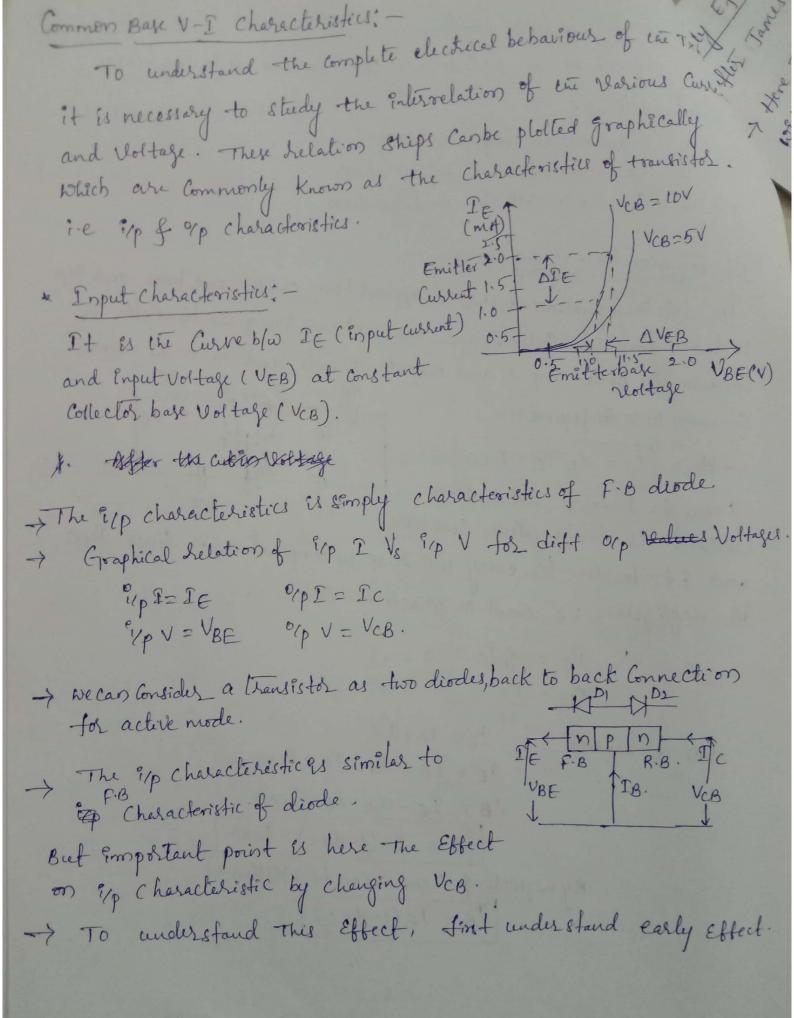
Current is temperature sensitive



$$\frac{1}{2} = \frac{2}{4} \int_{-\infty}^{\infty} dx = \frac{1}{2} \int_{-\infty}^{\infty$$

For a transistor. $I_{\varepsilon} = I_{\varepsilon} + I_{\varepsilon}$

By neglecting ICBO, Can be Written as IB = IE (1-dd.c)



Forly Effect - Known as bak width modulation. It is named (1) Fafter James M. Farly. This Effect found when we increase in VCB. -> Here J, F.B. J, R.B in R.B the width of depletion region estmore and mostly penetrale in to the Base region Be cause base is lightly doped.

The depletion Region has immobile ion's and -ve immobile ion's at Base and the immobile ions at Collector because it is mpor TXR. -> let say le = width of base (or) Metallergical base width W. = width of depletion layer penetrate into the Base region Meffective : Width of Base With no depletion region. WB= Weff+W. Weff = WB-W. Now if we in crease VCB 1 The heurs Moltage potential; wi will I, when wit Weff I. Where Weff is the Region where Lecombination takes place. Wit when Weff & The Chance of relombination at Base region . In this situation

-> The Other Season is increase in Concentration gradient 1. The en 'n side move from to Base, as the area decrease the Concentration gradient incheases. So more no of & move towards base This will also increase IE. 1. Le if we increase VCBT op voltage, the 910 Current It t. And The Lemaining characteristis are similar to FB of Porjunction.

After cuten voltage (0.7) for Si, The emitter Current IE & De sistement De la Constance (vers). It are means up. heristance is very small. Because is heristance of change in emitter base voltage (AVEB) to resulting to change in current (AIE) at Constant aver This heristance is Also known as dynamic hesistance of TXR in CB Configuration.

TI = AVEB | VCB - Const enchese

2) It can be observed That, there is slight thange in Emitter Current (IE) with increase in VCB. is due to change in width of depletion segion in the base region under the reverse biasemolition.

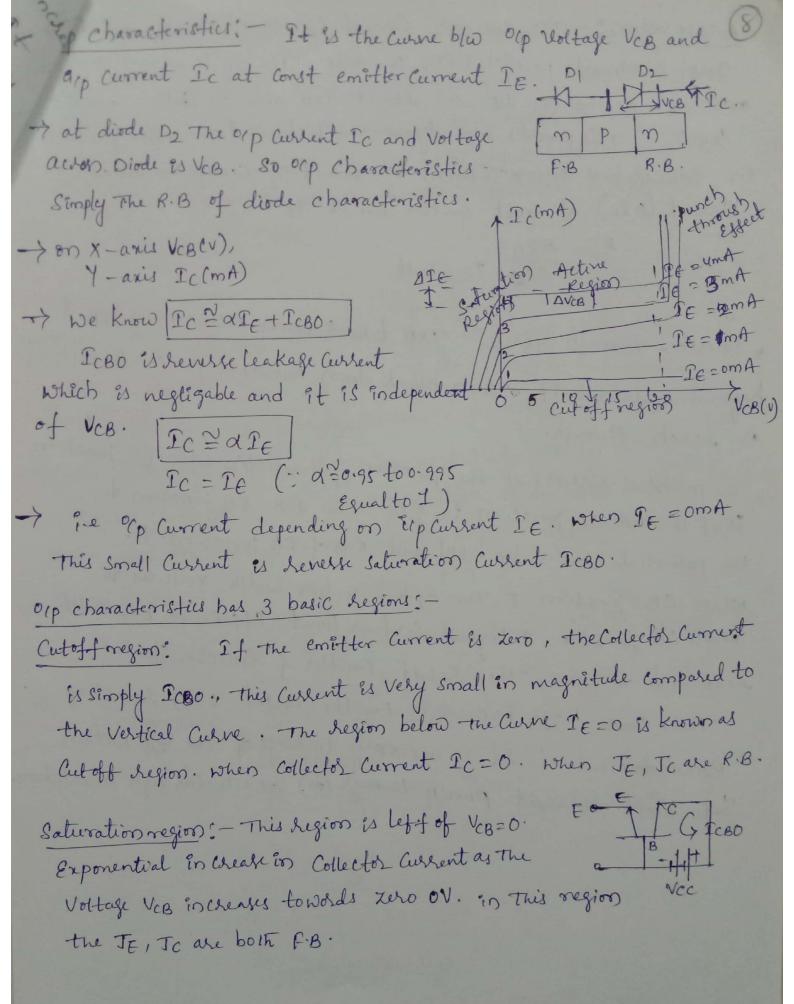
when R.B. Voltage VCB &, The width of depletion region also I, which reduces electrical base width. Due to reduction of The electrical base width, The concentration gradient I in the base region. This increase in concentration of charge Carriers causes more diffusion of electrical from n side to p side, that increase in IC Slightly.

Early Effect: - When R.B VCB +, The Width of depletion + which reduces I The electrical base Width. This effect is known as early Effect (3) Base Width modulation.

This & En base width has two Consequences;

- 1. There is less chance for recombination within The base region.

 Hence the transport factor d and β 1 with in collector junction Voltage.
- 2. The charge gradient increases within the base, & the Eument of minority careers injected across the junction increases.



Active region: The Collector Current is Almost Const, and If
graph is Almost parallel with X-axis. The IC is Always in.
on VcB. depent on IF So almost TXR acts as Gonst-Current of
Source: This provides high dynamic resistance Esthe ratio of change
in Collector base Voltage (AVCB) to resulting change in Collector
Current (AIC) at Const emitter Current IE.

Ro = DVCB | It = Gorst

* punch - through Effect? - TXR breakdown occurs when VCB 1 beyond Certain limit. Such break down known as punch through & Leach - through.

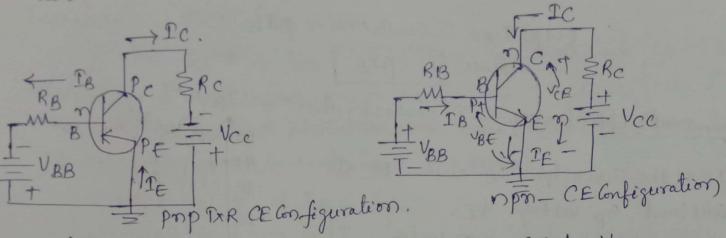
The potential barriers at the junction of transistor when EB junction is F.B and CB junction is R.B. The FB EB junction is the potential barrier by NeB and R.B of CB junction to when CB Junction to, The Effective base width reduces v. When CB Junction to beyond certain limit effective base width Near CB Junction to beyond certain limit effective base width leduces I to zero. Thus result Emitter of Collector shorted.

Thus Cause large in crease in Emitter Current (IE) resulting Breakdown. It is necessary to keep of the VCB within Safe limit to avoid punch through (or) heach through breakdow

The state of the s

Common Emitter-transistor : - Configuration.

In this Configuration Exp is applied b/w base and Emilter, and output is taken from the Collector and emitter. Here Emilter of transistor is Common for to both input and output ckts. and hence name is called Common Emilter Configuration.



As shown in fig: JE = F.B by VBB and Jc is R.B by VCC.

The input voltage in the CE Configuration is the base Emitter voltage

VBE, and op voltage is The Collector emitter voltage. The ip

Current is IB and op current is IC.

.. Now how the op Correct is relate with the 1/p Current IB.

... We have seen
$$I_C = \alpha I_E + I_{CBO}$$

$$I_{C} - I_{CBO} = \alpha I_E$$

$$\frac{I_C}{\alpha} - \frac{I_{CBO}}{\alpha} = I_E \qquad (\cdot : I_C - I_B + I_C)$$

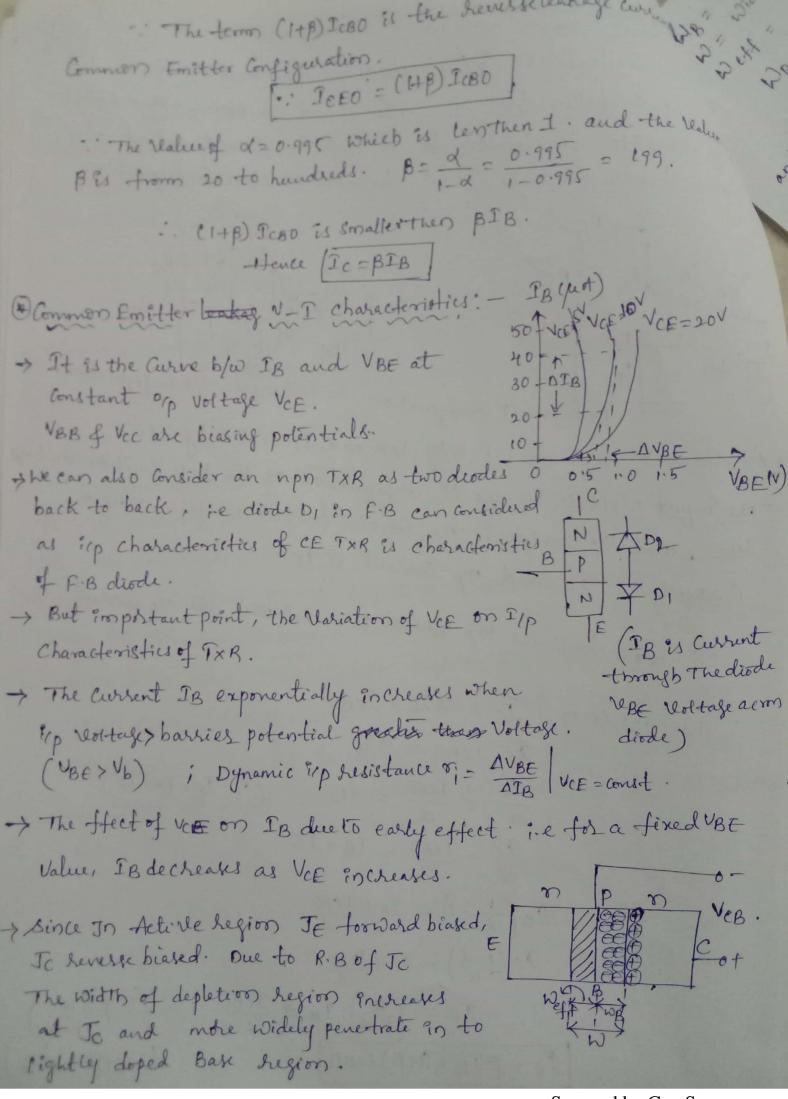
$$\frac{I_C}{\alpha} - \frac{I_{CBO}}{\alpha} = I_B + I_C$$

$$I_{C} \left(\frac{1}{\alpha} - I \right) = I_B + \frac{I_{CBO}}{\alpha}$$

$$I_{C} \left(\frac{1 - \alpha}{\alpha} \right) = I_B + \frac{I_{CBO}}{\alpha}$$

$$I_{C} = [A] = I_B + [A] = I_{CBO}$$

$$I_{C} = [A] = [A] = I_{CBO} = I_{CB$$



WB = Width of bak hegion W = width of depletion region in Base Weff = Effective base width without depletion hegion. MB = Weff + W 1 Metf = NB - W.T and VEE is orp voltage is VCB+ VBE if we increase VCE, VCB also incheases. NCE - TVCB + VBE " e VCE↑=> VCB↑ > W↑ > Weff V=> IBV (i/p Current)

When Weffe I, The region which recombination reduces, The & From Emitter are not becombine with holes present in Base it will reduce Base Current IB. Vice NOSSE.

When VCE 1 -> IB 1 lly-Viceversa VCE 1 -> IB 1. In V-I characteristics we can observe, by decreasing of voltage VCB b, it increase 1/p Current B T

Orp-characteristics: -To sate Aries out IB = 80 MA

TO Sate Aries IB = 80 MA

TO Sate Aries IB = 80 MA

TO Sate Aries IB = 80 MA Graphical helation blw of current Ic Vs tevels of IB. TO Saturate To Some To The op characteristics of Common Emitter Configuration Consists of three regions VCE O ! ICEO = (1+B) ICBO VCE(V) Active, Saturation and Cutoff.

1. Cutoff region: - when the ip base current is made Equal to Zero, The Collector Courrent Es reverse leakage Current ICEO. to make TXR act off region, it is not enough to reduce IB=0 instead, it is necessary to R.B the emitter base junction slightly. Here in this Situation Collector Current Equal to

Active region: — In the active region the curve is approximately horizontal is "active" region of CE Configuration. In the active region the Collector junction is R.B. As VCE increased, R.B. t. This Causes depletion to sphead more in base than in Collector hedusing the chances of recombination in the base. This increases the Velue of Odc. This collector Coassant larly effect causes, Ic to rise more sharply with increase in VCE in the active segion of orp characteristics. As by C&B.

When VCB - NCB + VBE
When VCB 1 => The Weff +> IB +> IC

Saturation:

Consider npn TxR wills two diodes.

TE

TB

-VCE = VCB + VBE

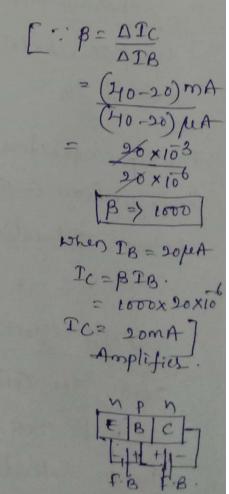
VCB = -VCE - VBE.

ES FB potential.

Here VCE is Very small inthis region.

Wehere. [VCB = IVCE-VBE]

make or diode also F.B.



Saturation Region: — If VCE is reduced to small Value i.e U. 0.2 V. the collector base junction becomes F.B., Since Emitter base junction is already F.B. by 0.7 V, the i/p junction in CE configuration is base to Emitter junction. which is always forward to operate transistor in active region. When both the junctions are in FB. Transistor operate in Saturation segion. which is indicated in orp characteristics. The saturation region. Which is indicated in orp characteristics. The saturation

punchthrough: — In the active region, the collector base junction is reverse biased, for every transistor there is a limit on maximum Value of R.B voltage. If the limit discreases (exceeded) breakdown occurs: in the TXB this effect is known as punchthrough effect.

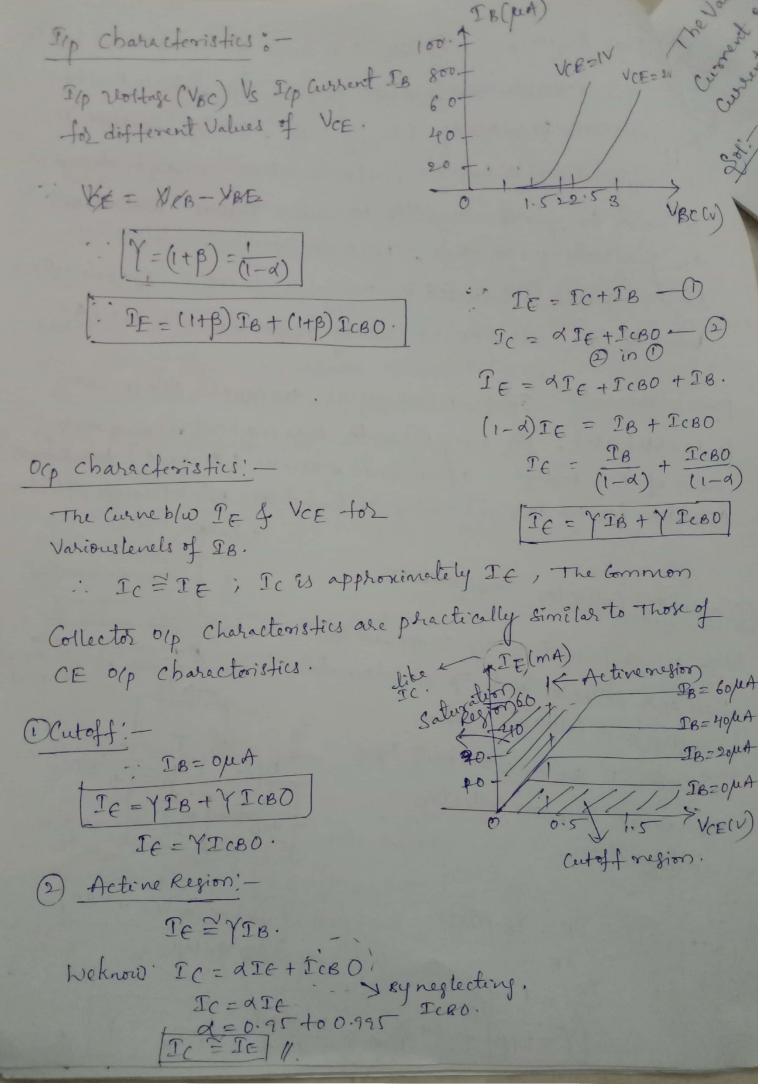
3 Common Collector Configuration:

In this configuration Ip es applied blw
Base and collector and op es taken from
Emitter and Collector. Here

Collector is common to both ripf orp Called Common Collector

Configuration.

Scanned by CamScanner



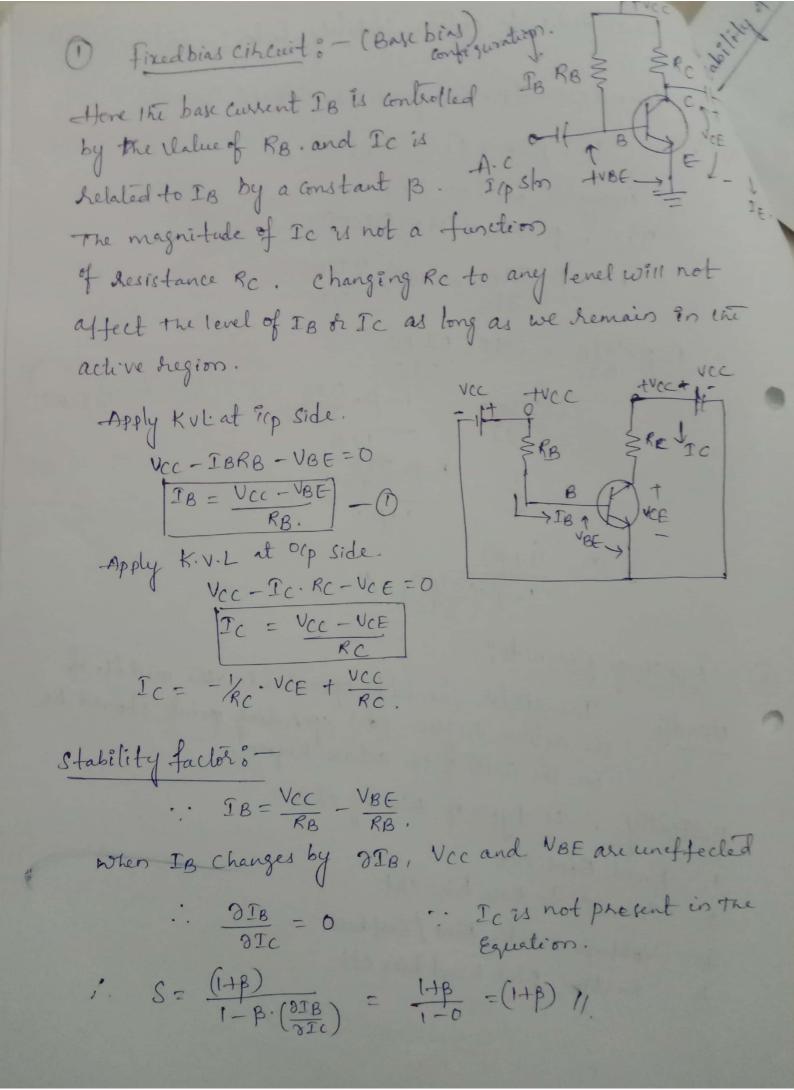
general procedure to obtain stability factor: - (5) For Common Emitter Configuration, Collector Current Ic = BIB + (1+B) ICBO. Apply of on both sides. DIC = p. DIB + (1+B) DICBO. 1 = B. DIB + (1+B) DICBO. 1-B. DIB = (1+B) DICBO $(:: S = \frac{\partial IC}{\partial ICBO})$ $\frac{\partial ICBO}{\partial IC} = \frac{1 - \beta \cdot \frac{\partial IB}{\partial IC}}{1 + \beta \cdot}$ $\frac{1}{S} = \frac{1 - \beta \cdot \frac{\partial IB}{\partial IC}}{1 + \beta \cdot}$ $S = \frac{(1+\beta)}{1-\beta \cdot (\frac{\partial IB}{\partial IC})}$ //.

Biasing Circuits o-

Need: - Transistor Should be operated in the middle of the active Jugion. (br) operating point should be in the centre of the active begion.

Basically, 4 types of Biasing Chts.

- 1. Fixed Bias ckt
- 2. Collector to Base bias ckt
- 3. Voltage di Vides Bias / Selfbias
- 4. Emitter Stabilized bias Ckt



$$I_{C} = \beta \cdot \frac{V_{CC}}{RB} - \beta \cdot \frac{V_{BE}}{RB} + (1+\beta)I_{CBO}.$$

$$\partial I_{C} = \beta \cdot \frac{V_{CC}}{RB} - \beta \cdot \frac{V_{BE}}{RB} + (1+\beta)I_{CBO}.$$

$$\frac{\partial I_{C}}{\partial \beta} = \left(\frac{V_{CC}}{RB} - \frac{V_{BE}}{RB}\right) + I_{CBO}.$$

$$\frac{\partial I_{C}}{\partial \beta} = I_{B} + I_{CBO}.$$

$$S' = \left(\frac{\partial I_{C}}{\partial \beta} - I_{B}\right) = \frac{1}{2}I_{CBO}$$

$$Relation b/\omega s and s'' s' - We know $S = (1+\beta)$, $S' = I_{C}/\beta$.$$

Relation b/w s and s'o
We know $S = (I+\beta)$, $S' = I'(\beta)$.

Multiplying numeralor and denominator by (I+B) $S' = Ic(I+\beta) = Ic \cdot S$ $S' = Ic(I+\beta) = Ic \cdot S$

* Disadvardages: - Since Ic=BIB, and IB is already fixed
Ic depends on B which changes unit to unit and shifts
The operating point.

Thus Stabilization of operating point is very poor in the fixed bias Circuit.

Collector to base bins: - (Collector feedback bins) In this biasing resistor is Connected blw Collector and Base 16 of the transistor. to provide feedback path. Thus IB flows through RB and (IctIB) through RC. PC & JIC+IB.

RB:
VOCE

VOCE By Applying KVL to the. base ckt. VCC - (IB+Ic) RC - IB. RB - VBE = O D. C bias with Nottage feed back VCC = (RB+RC) IB + IC. RC+VBE VCC = (RB+RC) IB + B.IB. RC + VBE IB = VCC-VBE (B >71) (1+p)Rc+RB IB = VCC-VBE RB+BRC By Applying KVL to Collector Ckt Vcc - (Ic+IB) Rc - VcE = 0 VCE = VCC - (IC+IB) RC. VCE - VCE = (IC+IB) RB. Stability factor for Collector to base bias & - TRB VCC - (IC+IB) RC + IB.RB - VBE = 0 VCC = ICRC+(RC+RB) IB + VBE. Apply 'o on both sides.

Ico Variations, we get stability against VBE Conditions also.

Stability factor(s); -S'= DIC | Ico. VBE const. KVL at Base cincuitary. VCC-(IC+IB) RC-IBRB-VBE=0 VCC-VBE = (BIB+IB) RC + IBRB. = IB (1+B) RC + PB JB = VCC - VBE (I+B) RC+ RB. D. Ic = B(VCC-VBE) (1+B)RC+RB SIC = [(1+B)RC+RB][VCC-VBE]-B[VCC-VBE]RC [(I+B) RC+RB]2 Tidt (V) = Vdu - udv DB = (VCC-VBE) [(+B)RC+RB-BRC] ((1+B)RC+RB)2 = [VCC-VBE] (CERRER RB+RC [(1+B)RC+RB]2 = (VCC-VBE)(RB+RC) : [(1+B)RC+RB][(1+B)RC+RB] (Typ) from (a) S = DIC = DC (RB+Re)

B(1+B)Re+RB]
M

Relation blw Sands": -S'=Pci(RB+Rc)' $S'=-S\cdot\beta$ $S'=-S\cdot\beta$ S= Ic x 3 /1+B. S=(1+B) 1+B(RC RC+RB) S = (RC+RB)(1+B) Thus if we provide stability against (RC+)
Thus if we provide stability against

Too Variation, we get stability B Variations also. B(1+B)RC+RB. (I+IB) ZR, ZRC (2 VD (3) Voltage divider Bias: ollow Strain Str -> Here biasing as provided by three resistors R, R, RE, RE. The resistors R1, R2 acts as potential divides giving a fixed Voltage to point Brach > If Collector Current Encreases due to change in temperature or change in B, The It increases and roltage drop across RE increases that Induces Voltage drop blw Base and Emiller VBE. Due to reduction in VBE Collector Current Ic reduces. -> Therefore we can say that negative feedback exists in the Emitter bias ckt. This reduction in Collector

aurent Ic Compensales For Original change in Ic.

Base circuit :-Let Gonsider base circuit IB VB TB TB Voltage achon R2 is The base Voltage VB. Applying Voltage divides theorem VB = R2.I x Vcc (: T>IB) $R_1(I+I_B)+R_2.I_B$ $V_B = \frac{R_2}{R_1 + R_2} \times V_{CC}$ Simplified Ckt of Voltage divides ckt; Here : R, of R2 are replaced by RB and VT, Where RB is the parallel Combination of RIGR2 and VT is the Thevening (RINRY) ICZRC+ Voltage. RB can be calculated as TIBVE L-TOTO SREVIE $R_B = R_1 || R_1 = \frac{R_1 R_2}{R_1 + R_2}$ Applying KVL at base ekt Trevenin's Equivalent VT-IBRB-VBE-IERE=0 CKt For Voltage divider bing VT = IBRB+VBE+IERE (TE = IB+Ic) VT = IBRB + VBE + (IB+IC) RE VT = IB(RB+RE) + VBE + ICRE. Apply's on both sides. VT = DIB (RB+RE) + VBE + DICRE. diff with off diff with ofc 0 = $\frac{\partial IB}{\partial IC}$ (RB+RE) + 0 = $\frac{\partial RB}{\partial IC}$ = $\frac{-RE}{RB+RE}$

(1+B) Stability factor (s) = 1-B(318) S= (+B) 1+B(RE+RB) Applying KVL to Collector ckt; VCC - ICRC - VCE - IERE = 0 IC = VCC - VCE - TERE $\frac{1+\beta}{1+\beta} = \frac{(1+\beta)(RE+RB)}{RE+RB+BRE}$ + with RE S= (1+B) (1+ RB/RE). RE (: RB/RE is Verysmall) ex! we can neglet BE (1+B)+(RB/RE) 8 = (1+p) = I To become S- small. RB - reasonablysmall. RE = not lenguage. .. If Ratio RB/RE is fixed, Sincreases with B. Therefore Stability decreases with incheses B. Not: - Stability factor 's' for voltage divider bias (or) self bias es les compared to other biasing circuits studiel. So this cht is most commonly preferred.

Relation Hw Sands 3= (1+B) (1+ RB/RE) (1+B) + RB/RE multiplying both numerator of denominator by RE weget S= (I+B) (RE+RB) RE(1+B)+ RB (IHB) (RE+RB) = RB+(IHB)RE - (1) => -@ sub@in@ S= -B RB+(1+B) RE me can see lower Value of 's' $S = \frac{-S \cdot \beta}{(1+\beta)(RE+RB)}$ 11 Lower as the Value of S. as we reduce the Value of 's' to both, VBE and Ico. Stability factor (s): -S' = DIC Ico, VBE Const. It is the Variation of Ic with B when Ico and VBE are Considered const. we trecall VBE = VT - (RB+(1+B) RE) x TC + [(RE+RB)(1+B)] ICO

Where
$$V = \begin{bmatrix} R_B + (H_B)R_E \end{bmatrix}_{T_C} + V$$

Where $V = \begin{bmatrix} R_B + R_E \end{pmatrix}_{(H_B)}^T = (R_B + R_E)_{T_C}^T = (R_B + R$

Figure shows fined bias ckt. Determine with \$ =100 otocc =60. i) operating point (ii) the stability factor of the color of the stability factor of the color o Cal: - (VCEOr, ICOr). Barckt VCC-IBRB-VBE=0=>6-IB. (530K2)-0.7=0 $I_B = \frac{6-0.7 \times 10^3}{530} = \frac{5.3}{530} \text{ mA} \Rightarrow \frac{53}{5300} \times 10^3 = 10^{11} = 10^{11} = 10^{11}$ IB = 10MA $f_C = \beta T_B \Rightarrow 100 \times 10 \times 10^6 = 1 \text{mA}$ Collector ckt Vcc - IcRc - VCE 20 6-1x18 x 2x16 - VE 20 operating VCE = 6-2 = 4V. point (VCEQ, ICQ) = (4V, 100A) Stability factor (s) = 1+10 = 101. (For fixed bins) The Small Value of Stability factor Endicales good bias Stability, whereas large value of Stability factor Endicales poor bias stability. Ideal Plake of stability factor is zero.
Since B is large quantity, this is a very pool.
bird stable cht.

(3) Calculate the quescent Current and Voltage of Collector to base bias arrangement Using The following dala. Vec= 100, RB = LOOKI, Rc = 2KI, B = 50, (and also specify a Value of RB 80 thd VCE 27V) looks ERC 02K ICA, VCER=? By Applying KUL to Base cht VCC - (IB+IC)RC - PBRB - VBE = O Vec - (IB+ BIB) RC - IBRB - VBE 20 VCC - IB (RB+ (1+B)RC) - VBE = 0 VCC - VBE = 10 - 0.7 RB+(1+B)RC = 100K+(1+50) 2×10 IB = VCC - VBE IB= 46 MA Ic = B. IB.

Ic = 1000 50×10 ×46) IC = 2.3mA/ By Applying KUL to Collector ext VCC - (IB+IC) BC - VCE = 0 VCE = VCC - (IBTIC) - BC VCE = 10. - (46/4A) (2×103) VCE = 5.308 V. (VCEQ, ICQ) = (5.308/2.3 mA)

M given VCE = 70 ; RB = ? VCC- (IC+IB) RC- VCE = 0. 10 = (IC+IB) RE = VCC - VCE (BIB+ IB) RE = VCC-VCE IB 20 = VCC-VCE = 10-7 (1+5) RC. = (1+50) ×2×10 TB= 3 = 29.41 MA Emitter Stabilized bias: -Applying KUL to Base cht

Applying KUL to Base cht

Vice - IBRB - VBE - IERE = 0

Vi CIVBE - ERE JIE By Applying KUL to Base cht VCC-IB-RB-VBE-(IB+IC) RE=0 VCC-VBE-IC-RE=IB(RB+RE) IB = VCC - VBE - ICRE

RB+RE , S= (1+B) 1+B. (21B) 27B = - RE REFRE 1 : S= (+B) 1+B(RE+RE) /.

